

规格书编号

SPEC NO:

产品规格书 SPECIFICATION

CUSTOMER 客 户:							
PRODUCT 产品:	SAW RESONATOR						
MODEL NO 型 号:	HDR303M-F11						
PREPARED 编 制:	CHECKED 审 核:						
APPROVED 批 准:	DATE 日 期:	2006-5-11					
客户确认 CUSTOMER RECEIVED:							
审核 CHECKED	批准 APPROVED	日期 DATE					

无锡市好达电子有限公司 Shoulder Electronics Limited



更改历史记录 History Record

更改日期 Date	规格书编号 Spec. No.	产品型号 Part No.	客户产品型号 Customer No.	更改内容描述 Modify Content	备注 Remark



1. SCOPE

This specification shall cover the characteristics of 1-port SAW resonator with used for remote-control security.

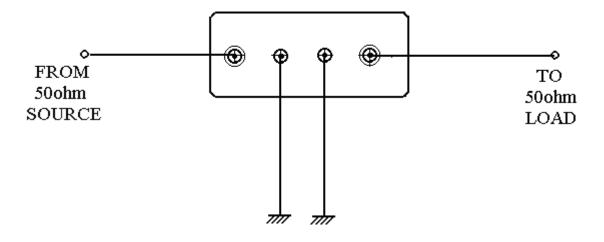
2. ELECTRICAL SPECIFICATION

DC Voltage VDC	10V		
AC Voltage Vpp	10V50Hz/60Hz		
Operation temperature	-20°C to +85°C		
Storage temperature	-45°C to +85°C		
RF Power Dissipation	0dBm		

Electronic Characteristics

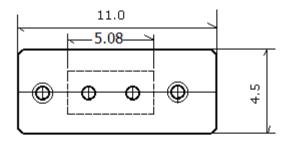
Item		Unites	Minimum	Typical	Maximum
Center Frequency		MHz	303.750	303.825	303.900
Insertion Loss		dB		1.7	2.5
Quality Factor Unload Q			8000	12000	
50Ω Loaded Q			1000	1500	
Temperature	Turnover Temperature	$^{\circ}$	10	25	40
Stability	Freq.temp.Coefficient	ppm/℃2		0.032	
Frequency Aging		ppm/yr		<±10	
DC. Insulation Resistance		МΩ	1.0		
RF	Motional Resistance R1	Ω		21	26
Equivalent	Motional Inductance L1	μН		171.87	
RLC Model	Motional Capacitance C1	fF		1.5967	
Transducer Static Capacitance		pF		2.0	

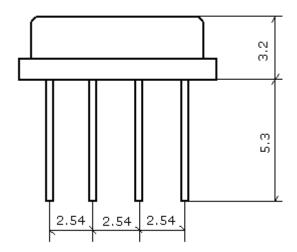
3. TEST CIRCUIT

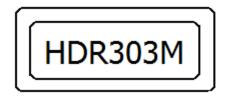




4. DIMENSION







5. ENVIRONMENTAL CHARACTERISTICS

5-1 High temperature exposure

Subject the device to +85 °C for 16 hours. Then release the resonator into the room conditions for 24 hours prior to the measurement. It shall fulfill the specifications in table 1.

5-2 Low temperature exposure

Subject the device to -20° C for 16 hours. Then release the device into the room conditions for 24 hours prior to the measurement. It shall fulfill the specifications in table 1.

5-3 Temperature cycling

Subject the device to a low temperature of -40° C for 30 minutes. Following by a high temperature of $+80^{\circ}$ C for 30 Minutes. Then release the device into the room conditions for 24 hours prior to the measurement. It shall meet the specifications in table 1.

5-4 Resistance to solder heat



SAW RESONATOR

HDR303M-F11

Dip the device terminals no closer than 1.5mm into the solder bath at $260^{\circ}\text{C} \pm 10^{\circ}\text{C}$ for 10 ± 1 sec. Then release the device into the room conditions for 4 hours. The device shall meet the specifications in table 1.

5-5 Solderability

Subject the device terminals into the solder bath at $245^{\circ}\text{C} \pm 5^{\circ}\text{C}$ for 5s, More than 95% area of the terminals must be covered with new solder. It shall meet the specifications in table 1.

5-6 Mechanical shock

Drop the device randomly onto the concrete floor from the height of 1m 3 times. the device shall fulfill the specifications in table 1.

5-7 Vibration

Subject the device to the vibration for 1 hour each in x,y and z axes with the amplitude of 1.5 mm at 10 to 55 Hz. The device shall fulfill the specifications in table 1.

5-8 Lead fatigue

5-8-1 Pulling test

Weight along with the direction of lead without an shock 1kg. The device shall satisfy all the initial Characteristics.

5-8-2 Bending test

Lead shall be subject to withstand against 90°C bending with 450g weight in the direction of thickness. This operation shall be done toward both direction. The device shall show no evidence of damage and shall satisfy all the initial electrical characteristics.

6. REMARK

6.1 Static voltage

Static voltage between signal load & ground may cause deterioration &destruction of the component. Please avoid static voltage.

6.2 Ultrasonic cleaning

Ultrasonic vibration may cause deterioration & destruction of the component. Please avoid ultrasonic cleaning

6.3 Soldering

Only leads of component may be soldered. Please avoid soldering another part of component.